



90824 (Docket No.)

**DECLARATION AND POWER OF ATTORNEY**

As a below named inventor, I hereby declare:

That my residence, post office address and citizenship are as stated below next to my name.

That I verily believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: ANTENNA MOUNTING PRINTED-CIRCUIT BOARD

the specification of which (check one)

( ) is attached hereto.

(X) was filed on October 27, 2003 as

Application Serial No. 10/694,598

and was amended on \_\_\_\_\_  
(if applicable)

That I have reviewed and understand the contents of the above-identified specification, including the claim, as amended by any amendment referred to above.

That I acknowledge the duty to disclose information known to be material to patentability of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

That I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate on this invention having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

2002-316544  
(Number)

JAPAN  
(Country)

30 October 2002  
(Day/Month/Year Filed)

Priority Claimed

☒ Yes ☐ No

\_\_\_\_\_  
(Number)

\_\_\_\_\_  
(Country)

\_\_\_\_\_  
(Day/Month/Year Filed)

☐ Yes ☐ No

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.

\_\_\_\_\_  
(Application Number)

\_\_\_\_\_  
(Filing Date)

\_\_\_\_\_  
(Application Number)

\_\_\_\_\_  
(Filing Date)

That I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)

(Status)-(Patented, pending, abandoned)

(Application Serial No.)

(Filing Date)

(Status)-(Patented, pending, abandoned)

I hereby appoint the following attorneys, with full power of substitution and revocation, to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith and request that all correspondence and telephone calls in respect to this application be directed to WELSH & KATZ, LTD., 120 South Riverside Plaza, 22<sup>nd</sup> Floor, Chicago, Illinois 60606, Telephone No. (312) 655-1500:

Attorney

Registration No.

A. Sidney Katz	24,003
Richard L. Wood	22,839
Jerold B. Schnayer	28,903
Eric C. Cohen	27,429
Joseph R. Marcus	25,060
Gerald S. Schur	22,053
Gerald T. Shekleton	27,466
James A. Scheer	29,434
Daniel R. Cherry	29,054
Edward P. Gamson	29,381
Kathleen A. Rheintgen	34,044
Thomas W. Tolpin	27,600
Jon P. Christensen	34,137
Eric D. Cohen	38,110
Walter J. Kawula, Jr.	39,724
Philip D. Segrest, Jr.	39,021
Mitchell J. Weinstein	37,963
Leonard Friedman	37,135
Steven E. Feldman	40,604
Jeffrey W. Salmon	37,435

Kenji Asakura

**Inventor's signature:**

Henry Asakura

Date:

November 10, 2003

**Residence and Post Office Address:**

c/o Sony Chemicals Corporation Neagari Plant

Ha-86. Akai-machi, Neagari-machi, Nomi-gun.

Ishikawa, Japan

**Citizenship:**

Japan

Full name of additional  
joint inventor, if any:

Hidenobu Muranaka

Inventor's signature:

Hidenobu Muranaka

Date:

November 10, 2003

Residence and Post Office Address:

c/o Sony Chemicals Corporation Neagari Plant

Ha-86, Akai-machi, Neagari-machi, Nomi-gun,

Ishikawa, Japan

Citizenship:

Japan

Full name of additional  
joint inventor, if any:

Shuichiro Yasuda

Inventor's signature:

S. Yasuda

Date:

November 10, 2003

Residence and Post Office Address:

c/o Sony Chemicals Corporation Neagari Plant

Ha-86, Akai-machi, Neagari-machi, Nomi-gun,

Ishikawa, Japan

Citizenship:

Japan

Address for Correspondence:

Eric D. Cohen  
WELSH & KATZ, LTD.  
120 South Riverside Plaza  
22nd Floor  
Chicago, Illinois 60606